



60V +175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	RDS(ON) MAX	ID MAX Tc = +25°C
60V	6.2mΩ @ V _{GS} = 10V	100A

Description

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

- Synchronus rectifiers
- DC-DC converters
- Power managements

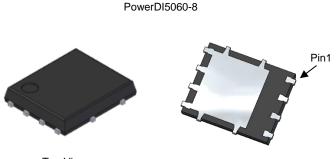
Features

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On State Losses
- Low Input Capacitance
- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

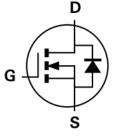
Mechanical Data

- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe;
 Solderable per MIL-STD-202, Method 208@3
- Weight: 0.097 grams (Approximate)

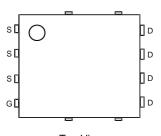
Site 1:







Internal Schematic



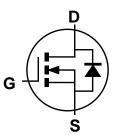
Top View Pin Configuration

Site 2:

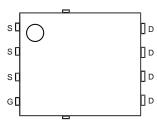
PowerDI5060-8/SWP (Type UX)



Bottom View



Internal Schematic



Top View Pin Configuration

Notes:

Top View

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

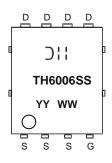


Ordering Information (Note 4)

Part Number	Packago	Packing		
Fait Number	Package	Qty.	Carrier	
DMTH6006SPS-13	PowerDI5060-8	2,500	Tape & Reel	
DMTH6006SPS-13	PowerDI5060-8/SWP (Type UX)	2,500	Tape & Reel	

Note:

Marking Information





☐ I = Manufacturer's Marking
TH6006SS = Product Type Marking Code
YYWW = Date Code Marking
YY or YY = Last Two Digits of Year (ex: 23 = 2023)
WW = Week Code (01 to 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V_{DSS}	60	V	
Gate-Source Voltage		Vgss	±20	V
Continuous Drain Current (Note 5) V 10V	T _A = +25°C	1-	17.8	A
Continuous Drain Current (Note 5) V _{GS} = 10V	T _A = +100°C	- I _D	12.6	
Continuous Dunin Compant (Nata C) V 40V	Tc = +25°C	ID	100	А
Continuous Drain Current (Note 6) V _{GS} = 10V	Tc = +100°C		75.9	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	400	Α	
Maximum Continuous Body Diode Forward Current (Note 6)	Is	100	Α	
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)	I _{SM}	400	Α	
Avalanche Current, L = 0.3mH	las	24.2	Α	
Avalanche Energy, L = 0.3mH	Eas	87.9	mJ	

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	2.94	W
Thermal Resistance, Junction to Ambient (Note 5)		$R_{\theta JA}$	51	°C/W
Total Power Dissipation (Note 6)	T _C = +25°C	P _D	107	W
Thermal Resistance, Junction to Case (Note 6)		Rejc	1.4	°C/W
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +175	°C

Notes:

- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
- 6. Thermal resistance from junction to soldering point (on the exposed drain pad).

^{4.} For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)		•		•	•	
Drain-Source Breakdown Voltage	BV _{DSS}	60	_	_	V	$V_{GS} = 0V$, $I_D = 1mA$
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 48V, V_{GS} = 0V$
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = 20V$, $V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	Vgs(th)	2	_	4	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
Static Drain-Source On-Resistance	RDS(ON)	_	4.8	6.2	mΩ	$V_{GS} = 10V, I_{D} = 10.5A$
Diode Forward Voltage	V_{SD}	_	0.8	1.2	V	$V_{GS} = 0V, I_{S} = 21A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	_	1721	_		N 201/ N 201/
Output Capacitance	Coss	_	740	_	pF	$V_{DS} = 30V$, $V_{GS} = 0V$, $f = 1MHz$
Reverse Transfer Capacitance	Crss	_	49	_		
Gate Resistance	R_g	_	0.6	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge	Qg	_	27.9	_		
Gate-Source Charge	Qgs	_	7.4	_	nC	V _{DS} = 30V, I _D = 21A, V _{GS} = 10V
Gate-Drain Charge	Q_{gd}	_	7.3	_		
Turn-On Delay Time	td(ON)	_	7.5	_		$V_{DD} = 30V, V_{GS} = 10V,$ $I_{D} = 10.5A, R_{g} = 4.7\Omega$
Turn-On Rise Time	t _R	_	8.2	_		
Turn-Off Delay Time	tD(OFF)	_	16.5	_	ns	
Turn-Off Fall Time	t _F	_	9.8	_		
Reverse Recovery Time	trr		37.0		ns	I- 24 A di/dt 200 A /v.o
Reverse Recovery Charge	Qrr	_	42.9	_	nC	I _F = 21A, di/dt = 300A/μs

Notes:

^{7.} Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.



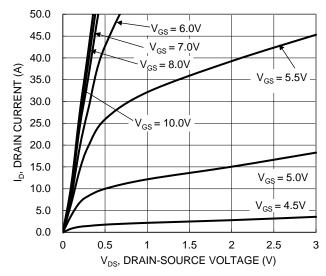


Figure 1. Typical Output Characteristic

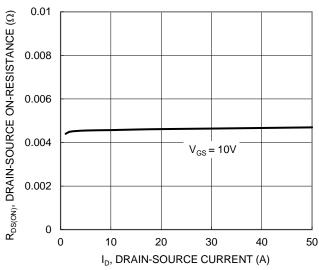


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

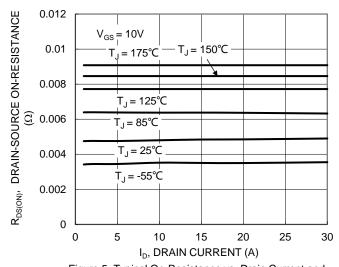


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

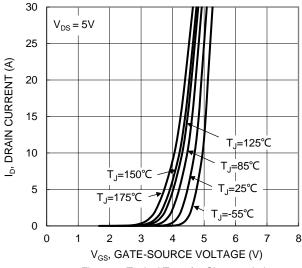


Figure 2. Typical Transfer Characteristic

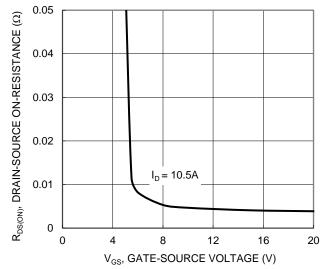


Figure 4. Typical Transfer Characteristic

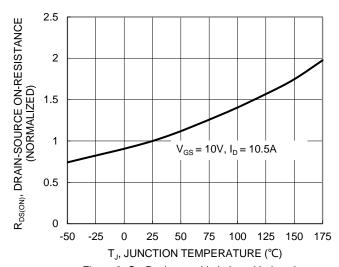


Figure 6. On-Resistance Variation with Junction Temperature





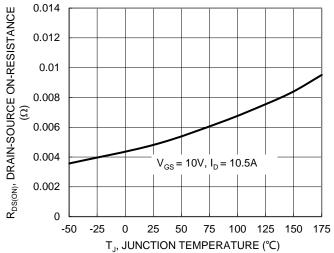


Figure 7. On-Resistance Variation with Junction Temperature

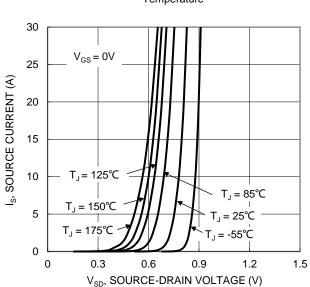


Figure 9. Diode Forward Voltage vs. Current

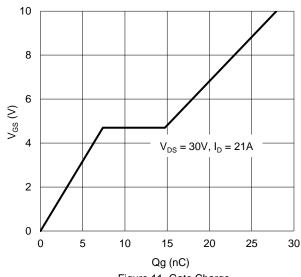


Figure 11. Gate Charge

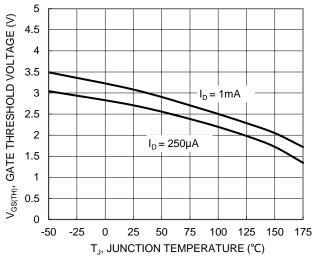


Figure 8. Gate Threshold Variation vs. Junction Temperature

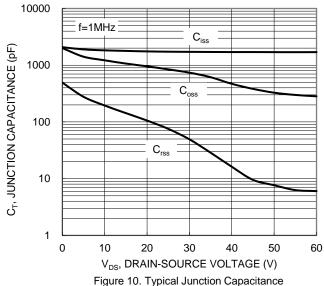


Figure 10. Typical Junction Capacitance

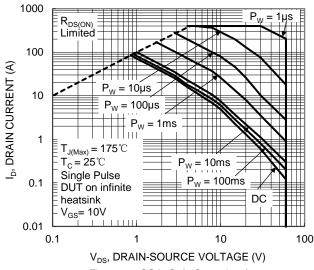


Figure 12. SOA, Safe Operation Area



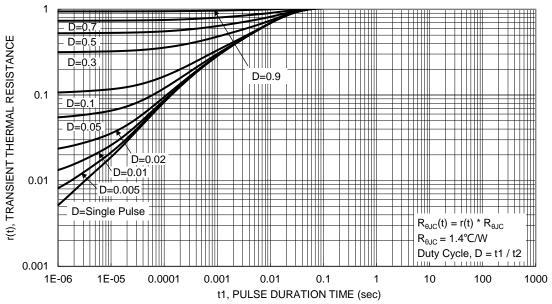


Figure 13. Transient Thermal Resistance

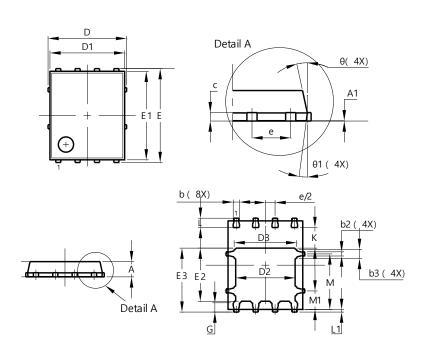


Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

Site 1:

PowerDI5060-8



PowerDI5060-8				
Dim	Min	Max	Тур	
Α	0.90	1.10	1.00	
A1	0.00	0.05	-	
b	0.33	0.51	0.41	
b2	0.200	0.350	0.273	
b3	0.40	0.80	0.60	
С	0.230	0.330	0.277	
D	,	5.15 BSC	;	
D1	4.70	5.10	4.90	
D2	3.70	4.10	3.90	
D3	3.90	4.30	4.10	
Е	(6.15 BSC	;	
E1	5.60	6.00	5.80	
E2	3.28	3.68	3.48	
E3	3.99	4.39	4.19	
е		1.27 BSC		
G	0.51	0.71	0.61	
K	0.51	_	-	
L	0.51	0.71	0.61	
L1	0.100	0.200	0.175	
М	3.235	4.035	3.635	
M1	1.00	1.40	1.21	
Θ	10°	12°	11°	
Θ1	6°	8°	7°	
All Dimensions in mm				

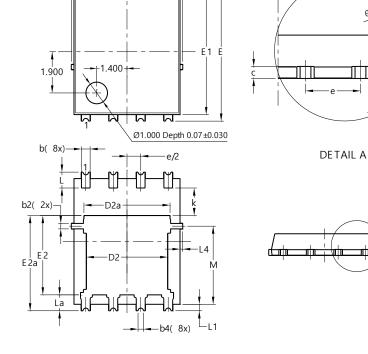
Site 2:

PowerDI5060-8/SWP (Type UX)

Seating Plane

OU MY

DETAIL A



Ро	PowerDI5060-8/SWP (Type UX)			
Dim	Min	Max	Тур	
Α	0.90	1.10	1.00	
A1	0	0.05		
b	0.30	0.50	0.41	
b2	0.20	0.35	0.25	
b4).25REF		
С	0.230	0.330	0.277	
D	5	.15 BS0	2	
D1	4.70	5.10	4.90	
D2	3.56	3.96	3.76	
D2a	3.78	4.18	3.98	
Е	6	.40 BS0	2	
E1	5.60	6.00	5.80	
E2	3.46	3.86	3.66	
E2a	4.195	4.595	4.395	
е		.27BSC		
k	1.05			
L	0.635	0.835	0.735	
La	0.635	0.835	0.735	
L1	0.200	0.400	0.300	
L1a	0.050REF			
L4	0.025	0.225	0.125	
М	3.205	4.005	3.605	
θ	10°	12°	11°	
θ1	6°	8°	7°	
All Dimensions in mm				

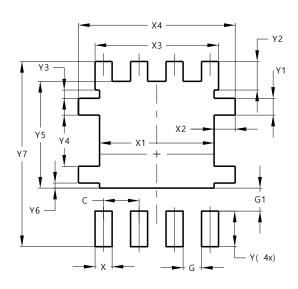


Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

Site 1:

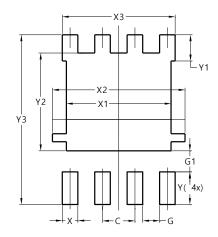
PowerDI5060-8



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
Х	0.610
X1	4.100
X2	0.755
Х3	4.420
X4	5.610
Υ	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
Y7	6.610

Site 2:

PowerDI5060-8/SWP (Type UX)



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
Х	0.610
X1	4.100
X2	5.190
Х3	4.420
Υ	1.270
Y1	1.020
Y2	3.810
Y3	6.610



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